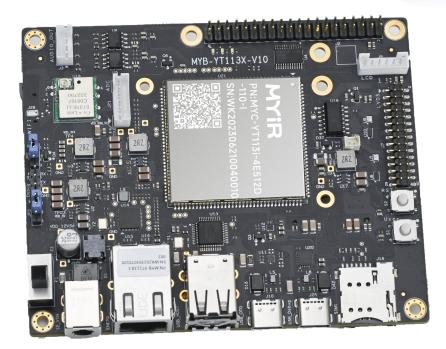
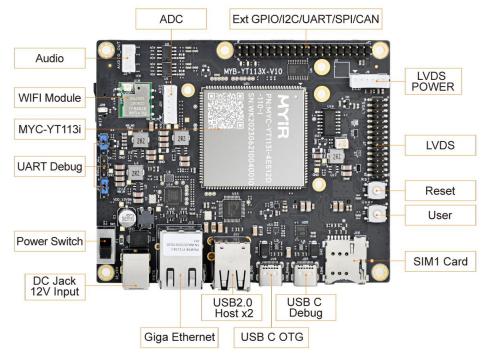


MYD-YT113i Development Board Overview

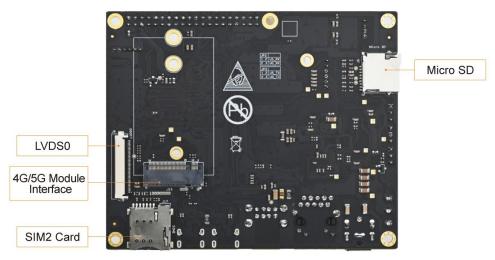


- ✓ MYC-YT113i CPU Module as Controller Board
- ✓ Up to 1.2GHz Allwinner T113-i Dual-core ARM Cortex-A7 MPU with Single-core HiFi4 DSP
- ✓ 512MB/1GB DDR3, 4GB/8GB eMMC, 32KB EEPROM
- ✓ UARTs, 2 x USB 2.0 HOST, 1 x USB 2.0 OTG, 1 x CAN, 1 x Gigabit Ethernet, WiFi, 4G/5G Module Interface, Micro SD card Slot
- ✓ 1 x Single-channel LVDS , 1 x Dual-channel LVDS, 1 x Audio Output
- ✓ Supports Running Linux 5.4 OS
- ✓ Optional LCD Module and RPI Module (RS232/RS485/CAN)

The MYD-YT113i Development Board is built around the MYC-YT113i CPU Module to provide a complete evaluation platform for ALLWINNER T113-i processor which features up to 1.2GHz Dual-core ARM Cortex-A7 MPU with a RISV slave core and a single-core HiFi4 DSP, targeting applications such as HMI, industrial automation, display and control terminals. It is provided with various RAM and Flash configurations to meet customers' different requirements, supporting 512MB/1GB DDR3 and 4GB/8GB eMMC. The base board has brought out rich peripherals through connectors and headers such as four UART ports, one Debug port, one Gigabit Ethernet, two USB 2.0 HOST and one USB 2.0 OTG, one Micro SD card slot, one M.2 Socket for 4G/5G LTE Module with two SIM card holders, one WiFi module, one GPIO/I2C/UART/SPI/CAN extension header, one single-channel LVDS and one dual-channel LVDS display interface, as well as audio output interface.



MYD-YT113i Development Board Top-view



MYD-YT113i Development Board Bottom-view

The <u>MYD-YT113i Development Board</u> is capable of running Linux OS. MYIR provides abundant software resources including image files, kernel and driver source code, application demos and compilation tools to enable users to start their development rapidly and easily. It is delivered with one Quick Start Guide, one USB to TTL serial cable and one 12V/2A power adapter. MYIR also offers <u>MY-WIREDCOM RPI Module</u> (RS232/RS485/CAN) and <u>MY-LVDS070C 7 inch LCD Module</u> as add-on options for the board.

Hardware Specification

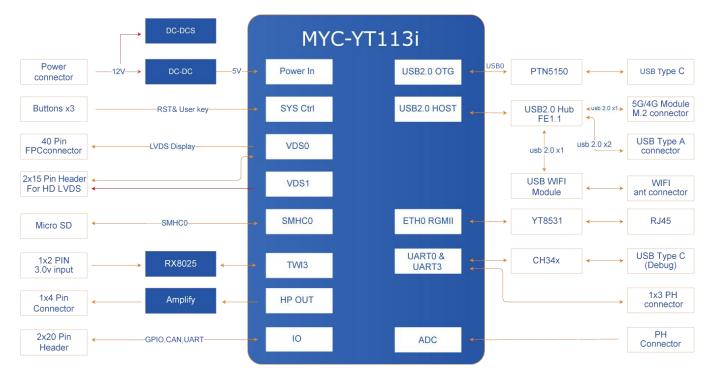
The <u>MYC-YT113i CPU Module</u> populated on the <u>MYD-YT113i Development Board</u> is using 13 x 13 mm, 337-LFBGA package Allwinner T113-i processor which is the Multi-Media decoding platform. T113-i integrates a 64-bit XuanTie C906 RISC-V CPU, a dual-core Arm Cortex-A7 CPU, and a HiFi4 DSP to provide the high-efficient computing power. It supports the full format decoding such as H.265, H.264, MPEG-1/2/4, JPEG, etc. The independent encoder can encode in JPEG or MJPEG. Integrated multi ADCs/DACs and I2S/PCM/DMIC/OWA audio interfaces can work seamlessly with the CPU to accelerate multimedia algorithms and improve the user experience. T113-i supports RGB/LVDS/MIPI DSI/CVBS OUT display output interfaces to meet the requirements of the different screen display. T113-i comes with extensive connectivity and interfaces, such as USB, SDIO, EMAC, TWI, UART, SPI, PWM, GPADC, LRADC, TPADC, IR TX&RX, etc. Besides, T113-i can connect with other different peripherals like Wi-Fi and BT via SDIO and UART.

Features	Description		
	• 64-bit Xuantie C906 RISC-V		
CPU	• Dual-core ARM Cortex -A7		
	- 32 KB L1 I-cache + 32 KB L1 D-cache per core, and 256 KB L2 cache		
	• Single-core HiFi4		
DSP	• 32 KB I-cache + 32 KB D-cache		
	• 64 KB I-ram + 64 KB D-ram		
Memory	• DDR2/DDR3, up to 2 GB		
	• SD3.0/eMMC 5.0, SPI Nor/NAND Flash		
	• Video decoding		
	- H.265 up to 4K@30fps - H.264 up to 4K@24fps		
Video Engine	- H.263, MPEG-1/2/4, JPEG, Xvid, Sorenson Spark, up to 1080p@60fps		
	• Video encoding		
	- JPEG/MJPEG up to 1080p@60fps		
	- Supports input picture scaler up/down		
	• Allwinner SmartColor2.0 post processing for an excellent display experience		
Display Engine	• Supports de-interlace (DI) up to 1080p@60fps		
	• Supports G2D hardware accelerator including rotate, mixer, lbc decompression		
	 CVBS OUT interface, supporting NTSC and PAL format 		
Video OUT	• RGB LCD output interface up to 1920 x 1080@60fps		
	• Dual link LVDS interface up to 1920 x 1200@60fps		
	• 4-lane MIPI DSI interface up to 1920 x 1080@60fps		
Video IN	• 8-bit parallel CSI interface		
	CVBS IN interface, supporting NTSC and PAL format		
	• 2 DACs and 3 ADCs		
Audio	• Analog audio interfaces: MICIN1P/N, MICIN2P/N, MICIN3P/N, FMINL/R, LINEINL/		
	R, LINEOUTLP/N, LINEOUTRP/N, HPOUTL/R		
	Digital audio interfaces: 12S/PCM, DMIC, OWA IN/OUT		
Connectivity	• USB2.0 OTG, USB2.0 Host		
	• SDIO 3.0, SPI x 2, UART x 6, TWI x 4, CAN x 2 • DWM (0, \pm) CDADC (2, \pm) LDADC (1, \pm) TDADC (4, \pm) D TYADY		
	• PWM (8-ch), GPADC (2-ch), LRADC (1-ch), TPADC (4-ch), IR TX&RX		
	• 10/100/1000M EMAC with RMII and RGMII interfaces		
Package	LFBGA 337 balls, 13 mm x 13 mm <i>Features of T113-i Processor</i>		

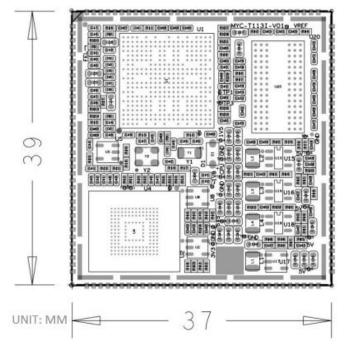
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Video Input	ARM Cortex-A7 x 2	HiFi4 DSP		Connectivity
Parallel CSI		I-cache 32 KB	D-cache 32 KB	USB2.0 OTG
CVBS IN	I-cache 32 KB 32 KB NEON Thumb-2 256 KB	I-ram	D-ram	USB2.0 HOST
ideo Output	SIMD /FPU	64 KB	64 KB	SDIO3.0
	RISC-V	Internal System		SPI x2 (Supports SPI Nand/Nor Flash)
MIPI DSI	Display Engine			TWI x4
RGB	DE	PLIC		UART x6
Dual link LVDS	DI	DMA		100M/1000M EMAC
-		Thermal Sensor		GPADC (2-ch)
CVBS OUT	G2D	Timer		TPADC (4-ch)
Audio	Video Engine	High Speed Timer		LRADC (1-ch)
Audio Codec				PWM (8-ch)
I2S/PCM x 3	Video Decoding H.265/H.264	Memory DDR2/DDR3 SD3.0/eMMC5.0		LEDC
				IR TX
DMIC	Video Encoding JPEG/MJPEG			IR RX
OWA IN/OUT	JFEG/MJFEG			SD3.0/eMMC5.0

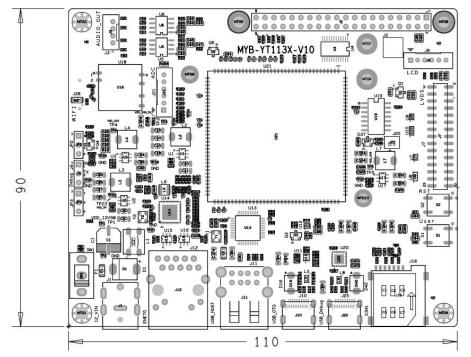
Allwinner T113-i Block Diagram



MYD-YT113i Development Board Function Block Diagram



MYC-YT113i Dimensions Chart (Unit: mm)



MYD-YT113i Dimensions Chart (Unit: mm)

The <u>MYD-YT113i Development Board</u> is using <u>MYC-YT113i CPU Module</u> as core controller board. It takes full features of T113-i processor and the main features are characterized as below:

Mechanical Parameters

- Dimensions: 110mm x 90mm (base board), 37mm x 39mm (CPU Module)
- PCB Layers: : 4-layer design (base board), 8-layer design (CPU Module)
- Power supply: +12V/2A (base board), 5V/1A (CPU Module)
- Working temperature: -40~85 Celsius (industrial grade) (WiFi Module: -20~70 Celsius)

The MYD-YT113i Controller Board (MYC-YT113i CPU Module)





MYC-YT113i CPU Module (Top-view and Bottom-view)

Processor

- Allwinner T113-i processor
 - Up to 1.2GHz Dual-core Arm Cortex-A7 CPU
 - Single-core HiFi4 DSP
 - Supports H.265/H.264 4K video decoding

External Memory

- 512MB/1GB DDR3
- 4GB/8GB eMMC
- 32KB EEPROM

Peripherals and Signals Routed to Pins

- 1.0mm pitch 140-pin Stamp Hole Expansion Interface + 50-pin LGA
 - 1 x RGMII/RMII
 - 2 x USB2.0
 - 6 x UART
 - 2 x CAN
 - 4 x TWI
 - 2 x SPI
 - 1 x GPADC and 4 x TPADC
 - 1 x MIPI DSI
 - 2 x LVDS
 - 1 x RGB
 - 1 x CVBS Out (TV Out)
 - 1 x Parallel CSI
 - 2 x CVBS In (TV In)
 - 2 x I2S

- Up to 81 GPIOs

Note: the peripheral signals brought out to the expansion interface are listed in maximum number. Some signals are reused. Please refer to the processor datasheet and the CPU Module pinout description file.

The MYD-YT113i Development Board Base Board

- 1 x Power Switch
- Serial ports
 - 1 x Debug UART (TTL)
 - 4 x TTL serial ports
- USB
 - 2 x USB2.0 Host ports (Type-A)
 - 1 x USB 2.0 OTG port (Type-C)
 - 1 x USB based WiFi Module
 - 1 x USB based M.2 socket for 4G/5G LTE Module
- 2 x SIM card slots
- Ethernet
 - 1 x 10/100/1000 Mbps Ethernet interface (RJ45)
- 1 x Micro SD card slot
- Display Interface
 - 1 x Single-channel LVDS interface Supports MYIR's MY-LVDS070C LCD Module with Capacitive Touch Screen through the LCD interface
 - 1 x Dual-channel LVDS interface
- 1 x Audio output port
- 1 x 2.54mm 2 x 20-pin male expansion header (GPIO/I2C/UART/SPI/CAN, compatible with Raspberry PI standard 40-pin extension interface) Supports MYIR's MY-WIREDCOM RPI Module to extend CAN / RS232 / RS485 functions
- 2 x Buttons (one for Reset and one for User)

MYIR Make Your Idea Real

Software Features

The <u>MYD-YT113i Development Board</u> supports Linux OS and comes with complete software package. The kernel and many peripheral drivers are available in source code to assist clients to expedite their development. The following are a summary of the software features:

Item	Feature	Description	Source Code
Bootloader	U-boot	Boot boot program uboot_2018.05	YES
Linux kernel	Linux kernel	Customized base on official kernel_5.4.61 version	YES
	USB Host	USB Host driver	YES
	USB OTG	USB OTG driver	YES
	I2C	I2C bus driver	YES
	SPI	SPI bus driver	YES
	Ethernet	YT8531SH driver	YES
	SDHI	EMMC/SD card storage driver	YES
	LVDS	LCD driver	YES
	Touch	Touch screen driver	YES
Device driver	Audio	SPDIF driver	YES
	Watchdog	Watchdog driver	YES
	4G/5G	4G/5G driver	YES
	PWM	PWM control driver	YES
	ADC	ADC driver	YES
	RTC	RTC driver	YES
	GPIO	Universal GPIO driver	YES
	UART	RS232/RS485/TTL driver	YES
	CAN	CAN driver	YES
	WIFI	RTL8731BU driver	YES
	t113i_linux_myir_emmc_core	Image built with Buildroot, excluding GUI interface	YES
Images	t113i_linux_myir_emmc_full	A fully functional image built with Buildroot	YES

MYD-YT113i Software Features

Order Information

Product Item	Part No.	Packing List
	MYD-YT113i-4E512D-110-I	 ✓ One MYD-YT113i Development Board (including MYC-YT113i CPU Module)
MYD-YT113i Development Board	MYD-YT113i-8E512D-110-I	 ✓ One USB to UART Debug cable ✓ One 12V/2A Power adapter
	MYD-YT113i-8E1D-110-I	 ✓ One DC Power jack adapter ✓ One Quick Start Guide
MYC-YT113i CPU Module	MYC-YT113i-4E512D-110-I	✓ One MYC-YT113i CPU Module
	MYC-YT113i-8E512D-110-I	
	MYC-YT113i-8E1D-110-I	
MY-LVDS070C 7-inch LCD Module	MY-LVDS070C	Add-on Options MY-LVDS070C 7-inch LCD Module MY-WIREDCOM Module
MY-WIREDCOM RPI Module	MY-WIREDCOM	
Note		

Note:

1. One MYD-YT113i Development Board includes one CPU module MYC-YT113i mounted on the base board. If you need more CPU module, you can order extra ones.

2. Discounts are available for bulk orders.

3. We provide OEM/ODM services to reduce time and save cost for customers.



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